

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	MDG/23/14393	
1.3 Title of PCI	ASE KaoHsiung (Taiwan) additional source PCN10689 information alignment - Lead finishing material information actualized for AMKOR ATP (Philippines) for LQFP 100 14x14 package - Addendum to PCI14025 to cover more commercial products	
1.4 Product Category	LQ14 product in e4 in AMKOR	
1.5 Issue date	2023-11-16	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.1.2 Marketing Manager	Pascal NARCHE
2.1.3 Quality Manager	Veronique BARLATIER

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General (Logistic)	(Not Defined)	ASE Kaohsiung (Taiwan) ST Muar (Malaysia) Amkor ATP (Philippines)

4. Description of change

	Old	New
4.1 Description	Lead Finishing: e3 - ASE Kaohsiung Taiwan - ST Muar Malaysia - Amkor ATP Philippines Lead Finishing : e4 - ST Muar Malaysia	Lead Finishing : e3 - no change - ASE Kaohsiung Taiwan - ST Muar Malaysia - Amkor ATP Philippines Lead Finishing : e4 - ST Muar Malaysia - no change - Amkor ATP Philippines - information added in documentation
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact - just information alignment	

5. Reason / motivation for change

5.1 Motivation	PCI14025 was issued as some missing information in the original PCN10689 documentation were misleading. Information has been re-aligned to stick to the actual product information. PCI14393 is just an addendum to PCI14025 to cover more commercial products.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	no change
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7. Timing / schedule

7.1 Date of qualification results	2023-03-22
7.2 Intended start of delivery	2023-12-20
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation			
8.1 Description	14393 MDG-MCD-RER1810 V7-ASE LQFP 7x7 10x10 14x14 20x20 STM8L STM32 -report.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2023-11-16

9. Attachments (additional documentations)			
14393 Public product.pdf 14393 MDG-MCD-RER1810 V7-ASE LQFP 7x7 10x10 14x14 20x20 STM8L STM32 -report.pdf 14393 PCI14393_Additional information.pdf			

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32F100VCT6	
	STM32F105VCT6W	
	STM32F205VGT6V	
	STM32F405VGT6V	



Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : ASE KaoHsiung (Taiwan) additional source

PCN10689 information alignment - Lead finishing material information actualized for AMKOR ATP (Philippines) for LQFP 100 14x14 package - Addendum to PCI14025 to cover more commercial products

PCI Reference : MDG/23/14393

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32F100VET6	STM32F207VGT6J	STM32F105VCT6W
STM32F205VGT6W	STM32F405VGT6W	STM32F100VDT6
STM32F407VGT6J	STM32F405VGT6J	STM32F205VGT6J
STM32F100VCT6	STM32F405VGT6V	STM32F205VGT6V
STM32F103VGT6J	STM32F105VCT6V	

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